Mechanical synthesis of high purity Cu–In–Se alloy nanopowder as precursor for printed CISe thin film solar cells

Armin E. Zaghi a,d,h,*, Marie Buffière b,d,h, Guy Brammertz e,f, Maria Batuk c, Nick Lenaers a,d,h, Bas Kniknie g, Joke Hadermann c, Marc Meuris e,f, Jef Poortmans h,d, Jef Vleugels b

a Department of Metallurgy and Materials Engineering (MTM), KU Leuven, Kasteelpark Arenberg 44, 3001 Heverlee, Belgium
b Institute for Material Research (IMO), Hasselt University, Wetenschapspark 1, 3590 Diepenbeek, Belgium
c Imec Division IMOMEC – Partner of Solliance, Wetenschapspark 1, 3590 Diepenbeek, Belgium
d Department of Metallurgy and Materials Engineering (MTM), KU Leuven, Kasteelpark Arenberg 44, 3001 Heverlee, Belgium
e Institute for Material Research (IMO), Hasselt University, Wetenschapspark 1, 3590 Diepenbeek, Belgium
f Imec – Partner in Solliance, Kapeldreef 73, 3001 Heverlee, Belgium
g Electron Microscopy for Materials Science (EMAT), University of Antwerp, Groenenborgerlaan 171, 201, 200 Antwerp, Belgium
h TNO, De Rondom 1, 5612 AP Eindhoven, The Netherlands

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Mechanical alloying and ball milling are low cost, up-scalable techniques for the preparation of high purity chalcogenide nanopowders to be used as precursor material for printing thin film solar cells. In this study, high purity copper indium selenium (Cu–In–Se) alloy nanopowders with 20–200 nm particle size were synthesized from macroscopic elemental Cu, In and Se powders via mechanical alloying and planetary ball milling. The particle size distribution, morphology, composition, and purity level of the synthesized Cu–In–Se alloy nanopowders were investigated. Thin Cu–In–Se alloy nanopowder ink coatings, deposited on Mo-coated glass substrates by doctor blading, were converted into a CuInSe2 semiconductor film by selenization heat treatment in Se vapor. The CuInSe2 film showed semiconducting band gap around 1 eV measured by photoluminescence spectroscopy. CuInSe2 absorber layer based thin film solar cell devices were fabricated to assess their performance. The solar cell device showed a total efficiency of 4.8%, as measured on 0.25 cm2 area cell.

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1. Introduction

Chalcogenide thin film solar cells are an important alternative for Si-based photovoltaic devices. Metal chalcogenide semiconductor materials such as CdTe–CdSe, CuIn1−xGax(S,Se)2 (CIGSe) and Cu2ZnSn(S,Se)4 (CZTSSe) have been developed as efficient light absorbing layers for thin film solar cell applications [1–4]. Due to the high fabrication costs of vacuum based techniques for manufacturing the chalcogenide thin film light absorbing layers, low cost non-vacuum fabrication techniques are being investigated. One of the most promising non-vacuum fabrication techniques for chalcogenide thin film PV, is based on solution processing and printing techniques [5–7]. In this approach, a thin layer of precursor ink is deposited on a substrate by a printing technique, subsequently dried to evaporate the solvents, and annealed in S, Se, H2S or H2Se containing atmospheres, i.e. chalcogenization, to form a polycrystalline CIGSe or CZTSSe chalcogenide semiconductor thin film with a typical thickness of 1–2 µm. In the printing approach for fabrication of the chalcogenide solar cells, one of the main technological challenges is the preparation of the initial precursor ink suspension suitable for printing [7]. Different approaches have been developed for the formation of precursor inks, which can be categorized in two general routes, i.e., the nanoparticle dispersion route and the solution route. The nanoparticle dispersion route is based on the dispersion of precursor nanoparticles in a liquid carrier [8,9], whereas the solution route is based on a complete dissolution of chalcogenide precursors in a solvent [10–13]. The applicability of these techniques is
evaluated by the quality of the resulting chalcogenide thin films, and the potential for up-scaling to an industrial scale process. Overall, the nanoparticle dispersion route seems to be more industrial applicable taking into account the higher freedom of choosing environmental friendly industrial solvents for high throughput printing, whereas the solution route requires hazardous solvents like hydrazine to dissolve chalcogenides [10–13].

Different approaches have been developed in recent years for the synthesis of nanoparticle precursors for chalcogenide materials, mostly focusing on chemical and solvothermal synthesis. Chemical nanoparticle synthesis is usually time consuming, relatively costly and requires sophisticated processing steps. Moreover, it is difficult to control the composition, size and morphology of the final chalcogenide nanoparticles, with a limited throughput [14,15]. Because of this, the applicability of the chemical route for industrial scale synthesis of chalcogenide nanoparticles is limited.

Ball milling on the other hand is conventionally used for the production of industrial dispersions and paints. This technique has been used for the synthesis of a variety of advanced nanomaterials [16,17]. Chalcogenide materials can also be synthesized by mechanical alloying and ball milling [18–23]. Unlike the chemical route, mechanical synthesis is fast, cost efficient, composition flexible, easy up-scalable and suitable for high throughput synthesis of powders and intermetallic alloys at an industrial scale [16]. Recently, the preparation of chalcogenide nanoparticle dispersions by colloidal wet ball milling has been reported [24–28].

The main drawback of mechanical synthesis and ball milling processes is the unavoidable contamination from the milling balls and vessel [16], whereas a high purity level is required for semiconductor and electronic materials. Therefore, the main challenge for implementing the mechanical alloying and ball milling for processing electronic and semiconductor materials is to limit the milling process contamination to an acceptable level.

In this study, high purity copper indium selenium alloy (Cu–In–Se) nanopowders were synthesized from elemental Cu, In and Se powders via mechanical alloying and planetary ball milling. The particle size distribution, morphology, composition, and purity level of the synthesized Cu–In–Se alloy nanopowders were investigated. Thin layers of Cu–In–Se alloy nanopowder were printed on Mo-coated glass substrates by doctor blade coating, followed by a drying process. The Cu–In–Se alloy nanopowder coating was converted into a CuInSe2 semiconductor film by selenization in selenium vapor. CuInSe2 absorber layer based thin film solar cell devices were fabricated to assess their performance.

2. Experimental procedures
2.1. Mechanical synthesis of the Cu–In–Se alloy nanopowder precursor

High purity elemental copper (99.999, 100 mesh powder, Alfa Aesar), indium (99.999, 3 mm shots, Chempur) and selenium (99.999, 3 mm shots, Alfa Aesar) were used as starting materials. Mechanical alloying was performed on a high energy planetary ball mill (PM400-AM, Retsch) at a rotational speed of 350 RPM. Elemental copper, indium and selenium with a stoichiometric Cu:In:Se mole ratio of 85:100:100 were loaded in yttria-stabilized zirconia (Y-TZP) milling balls in an amine (n-butylamine) wet medium. Additional wet milling for 2–5 h at 350 RPM resulted in nanometer-sized powder. The particle size range could be controlled by adjusting the ball to powder ratio and the wet milling time. After the wet milling process the Cu–In–Se alloy nanopowder was separated from amine solvent via centrifuging, and sufficiently washed with ethanol to remove the amine solvent.

2.2. CuInSe2 semiconductor film formation via Cu–In–Se alloy nanopowder printing and selenization

In order to form a dense and uniform CuInSe2 thin film via printing, a dispersion ink of the Cu–In–Se alloy nanopowder in 1,5-Pentanediol with a concentration of 250 mg/ml, was printed using a doctor blade coating tool (Erichsen 409), applying approximately a 20 µm wet layer thickness on a 5 × 5 cm2 molybdenum-coated glass substrate followed by a drying process at 100 °C in Nitrogen atmosphere. After drying, a 1–2 µm thick coating of Cu–In–Se alloy nanopowder remained on the substrate. The dried nanopowder precursor coating was annealed in a graphite box containing elemental selenium shots in Argon at 250 °C for 10 min and 500 °C for 20 min in a home-made RTP tube furnace, resulting in a dense polycrystalline CuInSe2 film.

2.3. Solar cell processing

For completing the thin film solar cell structure, a standard procedure for CIGS based solar cells was used, consisting of a KCN etch, chemical bath deposition of a thin n-type CdS buffer layer and AC-sputtering of 60 nm of intrinsic ZnO followed by 350 nm of highly Al-doped ZnO. Finally, a 50 nm Ni-1 µm Al finger grid pattern was evaporated through a shadow mask for top contact formation. Lateral isolation of the cells was performed by needle scribing. In this way, solar cell devices with sizes ranging from 0.25 to 1 cm2 were fabricated on 5 × 5 cm2 substrates.

2.4. Characterization

The produced Cu–In–Se alloy nanopowders were characterized by different analytical techniques. The morphology and composition of the synthesized Cu–In–Se alloy nanopowders and the final CuInSe2 film were evaluated by scanning electron microscopy (SEM, XL30-FEG, FEI), equipped with an energy dispersive X-ray analysis system (EDS, EDAX). The crystal structure of the produced Cu–In–Se alloy nanopowders were evaluated by X-ray diffraction (XRD, 3003 TT, Seifert) with a Cu Kα source. The particle size distribution after mechanical alloying and wet ball milling was measured by photon cross-correlation spectroscopy (Nanophox, Sympatec). The nanostructured nature of the synthesized Cu–In–Se alloy nanopowders was investigated by high angle annular dark field scanning transmission electron microscopy (HAADF-STEM) and energy dispersive X-ray (EDS) analysis (TEM, Tecnai, G2, 200 kV). The sample for TEM investigation was prepared in the following way: the suspension of the Cu–In–Se alloy nanopowder in ethanol was dispersed in an ultrasonic bath for 10 s, and several drops of the obtained suspension were deposited on a copper grid covered with a holey carbon film.

The zirconia contamination from the Y-TZP milling balls and milling vessels in the milled Cu–In–Se alloy powders was determined by ICP-AES (Inductively Coupled Plasma Atomic Emission Spectroscopy). The milled Cu–In–Se alloy powders were dissolved in a solution of concentrated hydrochloric acid and nitric acid. The zirconium concentration in solution was determined by atomic...
emission spectroscopy using standard zirconium solutions in the same acidic media.

The band gap of the CuInSe₂ semiconductor film was measured by photoluminescence spectroscopy on a Hamamatsu C12132 near infrared compact fluorescence lifetime measurement system. The electrical characterization of the solar cell devices were performed by light and dark current–voltage (I–V) measurements using an Oriel solar simulator using an AM1.5D spectrum with an illumination density of 1000 W/m² and a Keithley 2600 Sourcemeter for curve tracing, and by external quantum efficiency measurement (EQE) at room temperature using a grating monochromator-based dual-beam setup (model Bentham 605) under chopped light from halogen and xenon lamps.

3. Results and discussion

3.1. Cu–In–Se alloy nanopowder precursor

The reaction between metals and chalcogens, i.e., sulfur or selenium, are known to be extremely exothermic, and can be initiated by mechanical agitation resulting into a self-propagated reaction [21,22]. High energy ball milling also caused mechanical alloying of elements. As a result, after a few hours of high energy ball milling, the elemental copper, indium and selenium powders were alloyed into a homogeneous intermetallic alloy powder. Fig. 1(a and b) shows a scanning electron micrograph and particle size distribution, as measured by laser diffraction (Mastersizer Plus, Malvern) of the Cu–In–Se alloy powder after mechanically alloying for 2 h at 350 rpm. The alloyed Cu–In–Se powder was micrometer sized with a major particle size distribution in the 1–10 µm range.

The alloyed Cu–In–Se powder was milled further in a wet ball milling process in n-butylamine using 3 mm Y-TZP milling balls. The particle size of the Cu–In–Se alloy powder reduced significantly into the nanometer size range. The particle size distribution of the Cu–In–Se alloy nanopowder can be adjusted by controlling the milling time. The SEM images and particle size distributions of the Cu–In–Se alloy nanopowder after wet milling are presented in Fig. 1. The particle size distribution, as measured by photon cross-correlation spectroscopy (Nanophox), after 2 h of wet milling was in the 200–800 nm range, Fig. 1(c and d). After 5 h of wet milling, the main Cu–In–Se alloy particle size distribution is below 100 nm with additional particles size distribution in the 200–500 nm range, which are most probably agglomerates, as shown in Fig. 1(e and f).

Fig. 1. SEM images and particle size distributions of the Cu–In–Se alloy powder after 2 h of mechanical alloying (a and b), and Cu–In–Se alloy nanopowders after 2 h (c and d) and 5 h (e and f) of additional wet ball milling.
The XRD patterns of the Cu–In–Se alloy powders after mechanical alloying and Cu–In–Se alloy nanopowders after wet milling process are compared in Fig. 2. The broad diffraction peaks and the wide background bump in the XRD pattern, indicates that the mechanically synthesized Cu–In–Se alloy powder and nanopowders are nanocrystalline and partially amorphous. The broad diffraction peaks that can be indexed as CuInSe₂ chalcopyrite (JCPDS card No. 40-1487), Cu₂In phase (JCPDS card No. 42-1475) and CuSe phase (JCPDS card No. 27-184), as illustrated in Fig. 2(a), imply the partial formation of nanocrystalline CuInSe₂, CuSe, and Cu₂In phases during mechanical alloying due to the fact there is not enough Se available for complete conversion to CuInSe₂. The same main diffraction peaks were present in the XRD pattern of the Cu–In–Se alloy nanopowders after additional wet milling, although the diffraction peaks are wider, due to the further size reduction, as shown in Fig. 2(b and c). The nanostructure and phase composition of the Cu–In–Se alloy nanopowder is advantageous for sintering and grain growth during selenization to finally form a continuous crystalline CuInSe₂ phase film.

An overview TEM image of the Cu–In–Se alloy nanopowder after 2 h wet milling is presented in Fig. 3 together with the high resolution (HR) TEM image and the electron diffraction (ED) pattern. The Cu–In–Se alloy nanopowder is composed of highly agglomerated crystalline and amorphous nanostructures, nanoparticles with a size of a few nanometers and rod-like nanoparticles with the length of 50–150 nm. The ED pattern consists of rings corresponding to the polycrystalline tetragonal CuInSe₂ phase (JCPDS card No. 40-1487) which corroborates the XRD data. Additional reflections on the ED pattern are attributed to the CuSe phase.

Energy dispersive spectroscopy (EDS) elemental maps of the Cu–In–Se alloy nanopowder are shown in Fig. 4. The EDS maps were generated from the intensity of the Se–K, Cu–K and In–L lines indicating the heterogeneous composition of the Cu–In–Se alloy nanopowder. The EDS maps confirm that the nanoparticles are attributed to the CuInSe₂ phase, whereas the crystalline rod-like nanoparticles are mainly composed of copper and selenium in the form of CuSe. According to HR-TEM and EDS analysis, indium-rich amorphous nanoparticles are also present.

A high purity level is essential for semiconductor material applications. In general, chalcogenide semiconductors have a higher tolerance to structural defects and impurities, due to their solid electronic structures [29,30]. However, the purity level and processing contamination should be carefully monitored. During
mechanical alloying and ball milling, contamination from the milling balls and milling vessel is unavoidable. The level of milling contamination however can be controlled and limited using high wear resistant Y-TZP milling balls and vessels and optimized milling parameters like ball to powder ratio, milling speed and milling time [16]. When using Y-TZP milling balls and jars, yttria-stabilised ZrO₂ is the only contaminant in the produced powder.

The zirconium concentration in the different batches of mechanically alloyed and wet milled nanopowders was measured by Inductively Coupled Plasma Atomic Emission Spectroscopy (ICP-AES), as summarized in Table 1. The concentration of zirconium in the Cu–In–Se alloy powder is around 40–70 ppm after mechanical alloying and 100–300 ppm in the additional wet milled Cu–In–Se alloy nanopowders. The zirconium contamination level is in the same range as reported for mechanically synthesized BSCO superconductor powders [31].

### 3.2. CuInSe₂ semiconductor film

The Cu–In–Se alloy nanopowder that was formed after 2 h of the wet milling process, was dispersed in 1,5-Pentanediol solvent to form an ink and doctor bladed on a molybdenum coated glass substrate. By drying of the coating, a uniform and crack-free Cu–In–Se alloy nanopowder coating was formed, as illustrated by the SEM images taken from the surface and cross-section of the coating presented in Fig. 5.

The Cu–In–Se alloy nanopowder coating was converted by recrystallization and sintering into a dense and continuous CuInSe₂ film by a two step consecutive thermal annealing process (selenization) in Argon containing Se vapor at 250 °C for 10 min and 500 °C for 20 min.

A micrometer large grained CuInSe₂ phase microstructure was formed after two step selenization in Se vapor, as shown in Fig. 6(a and b). According to the EDS measurements, the selenized CuInSe₂ film contained 24 at.% Cu, 28 at.% In and 48 at.% Se, corresponding to copper poor CuInSe₂ phase with an optimum Cu/In ratio of 0.85 for p-type semiconducting properties [32]. The XRD pattern of the film after selenization shows sharp diffraction peaks in contrast to the as-synthesized Cu–In–Se alloy nanopowder (Fig. 2) confirmed the recrystallization and grain growth of the Cu–In–Se alloy nanopowder into a CuInSe₂ phase during selenization. Photoluminescence spectroscopy (PL) performed on the selenized CuInSe₂ film shows a PL peak around 1 eV, corresponding to the semiconducting band gap of the CuInSe₂ phase, as illustrated in Fig. 6(d).

### 3.3. Solar cell device performance

In order to assess the potential of the Cu–In–Se alloy nanopowder as precursor for printed CuInSe₂ solar cells, SLG/Mo/CuInSe₂/CdS/ZnO/AZO photovoltaic devices were fabricated, as described in the experimental part. Fig. 7(a) shows a cross-section SEM image of the solar cell. The CuInSe₂ film is composed of a well-sintered
The CuInSe₂ absorber film consists of a top layer with relatively large grains, and a bottom layer with a smaller grain size below 200 nm. Although both layers are converted into the CuInSe₂ phase, the higher degree of sintering and grain growth observed in the top part of the CuInSe₂ absorber film could be due to the higher Se flux at the surface of the printed film.

The electrical $J-V$ characteristic of the representative best solar cell is presented in Fig. 7(b). For this device, a total area efficiency of 4.8% was measured on 0.25 cm² with an open circuit voltage $V_{oc}$ of 371 mV, a short circuit current density $J_{sc}$ of 29.6 mA/cm² and a fill factor of 44.0%. The cross-over effect, i.e., the non-superposition of the light and dark $J-V$, observed for this device has been extensively reported in literature for CuInSe₂ based solar cells [33].

Fig. 7(c) shows the external quantum efficiency (EQE) spectrum measured on the same device. The EQE signal reaches values up to 77% in the short wavelength range, indicating good carrier collection for photo carriers generated close to the CdS interface. The decrease of the collection of the photocurrent in the long wavelength range could be explained by the bilayer structure observed in Fig. 7(a) and would indicate that the poorly sintered bottom layer is less efficient for carrier collection as compared to the top CuInSe₂ layer due to a larger amount of defects at the free surface of the grains. Further investigation is currently in progress to verify this hypothesis. The $J_{sc}$ extracted from the integration of the EQE signal is slightly lower than the one measured by $J-V$ analysis, most probably due to the inhomogeneous distribution of the current over the area of the cell. The derivative of the EQE at the long wavelength range indicates a value of the CuInSe₂ band gap estimated around 1.03 eV, which is in good agreement with the PL measurements. Finally, the very low intensity of optical interference losses as compared to a standard CuInSe₂ solar cell can be explained by the high average roughness of the printed CuInSe₂ absorber layer. In conclusion, the Cu-In-Se alloy nanopowder is a very promising precursor for the manufacturing of printed CuInSe₂ solar cells.

Fig. 5. Top (a) and cross-sectional (b) SEM view of the Cu-In-Se alloy nanopowder coating.

Fig. 6. Top (a) and cross-sectional (b) SEM image of the CuInSe₂ film after selenization together with the XRD pattern (c) and photoluminescence spectroscopy spectrum (d).
4. Conclusions

Copper indium selenium (Cu–In–Se) alloy was synthesized from elemental powders via mechanical alloying. Additional planetary wet ball milling in an amine solvent allowed to reduce the particle size of the Cu–In–Se alloy powder into the nanometer size range. The zirconium contamination from the zirconia milling ball/jar based process to obtain Cu–In–Se alloy nanopowder was determined to be below 250 ppm. The milled Cu–In–Se alloy nanopowder, composed of a mixture of amorphous and nanocrystalline CuInSe₂, CuSe and In₅Se₃ phases, transformed into a single phase polycrystalline CuInSe₂ film during the selenization process. A CuInSe₂ semiconductor film was prepared by doctor blade coating and selenization of the Cu–In–Se alloy nanopowder. Finally a solar cell device was fabricated from the prepared CuInSe₂ absorber layer with a standard cell structure for chalcogenide thin film solar. The solar cell device showed a total area efficiency of 4.8%, as measured on 0.25 cm² area with fill factor of 44.0%. Altogether, it can be concluded that combined mechanical alloying and ball milling of elemental powders can be used as a fast, up-scalable, low cost technique for the preparation of high purity chalcogenide nanopowders for printing thin film PV applications.

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